## SuperB IFR electronics: update

Angelo Cotta Ramusino on behalf of the IFR collaboration





• Highlights from the workshop: **"Instrumentation for muon and KOL identification at Super Flavor Factories",** 6-10 Sep 2012, Institute of Nuclear Physics, Polish Academy of Sciences, Kraków, Poland

• Preparatory work for the design of a prototype IFR frontend ASIC







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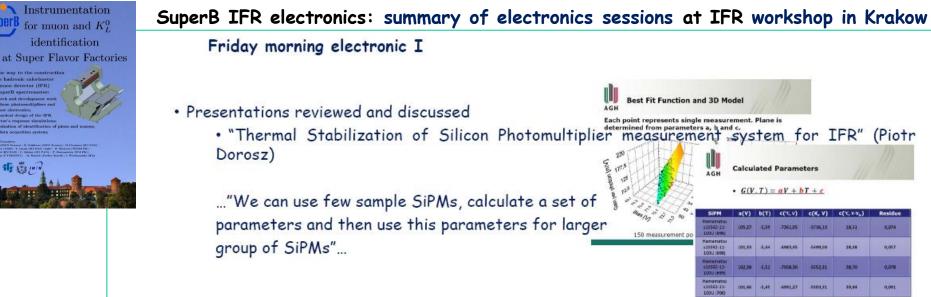
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IFJ-PAN

Mr. ZIOLKOWSKI, Pawel



Kraków POLAND



• G(V,T) = aV + bT + c0537 .558 18.51 101.83 .5,44 28,48 0,057 38.25 0.078 2011.005 36.85 1689137 15503 41 10.11

**Calculated Parameters** 

"SiPM test with thermal neutrons at the IRMM" (A. Cotta Ramusino)

... Low energy neutron are not as harmless as one could think ...

... Analysis on-going on the effects of shielding ...

... After a thermal neutron irradiation equivalent to 2 years of SuperB operation (with safety factor of 5) SIPM signals picked up at the analog test poi SiPM dark rate has increased and pile up effect occur -> constraints on shaping time of front end electronics

... pulse height for single p.e. remains constant





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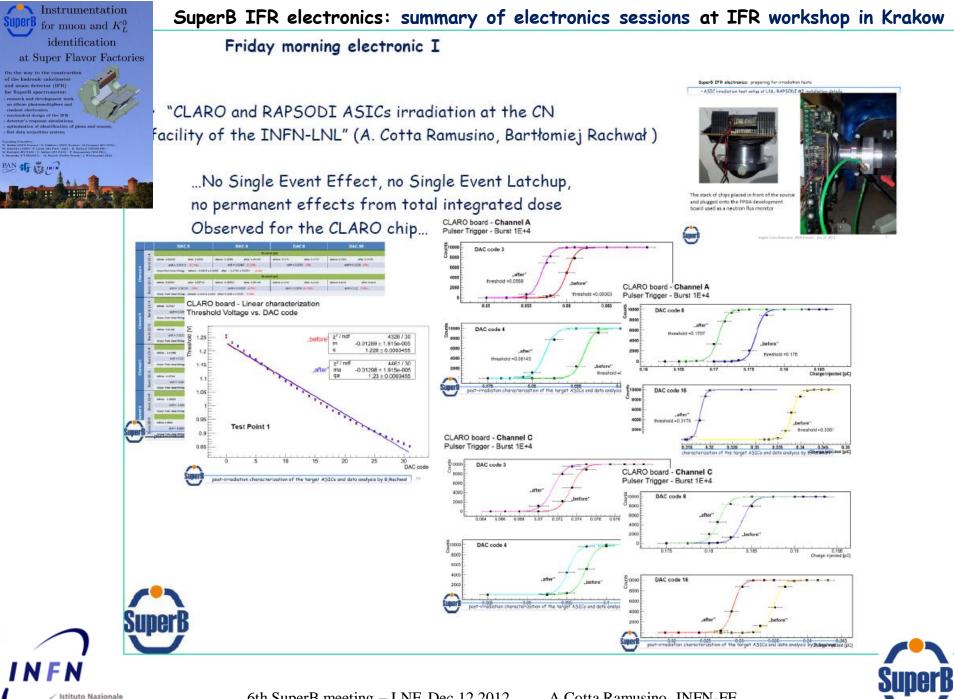
uon detector (IFR

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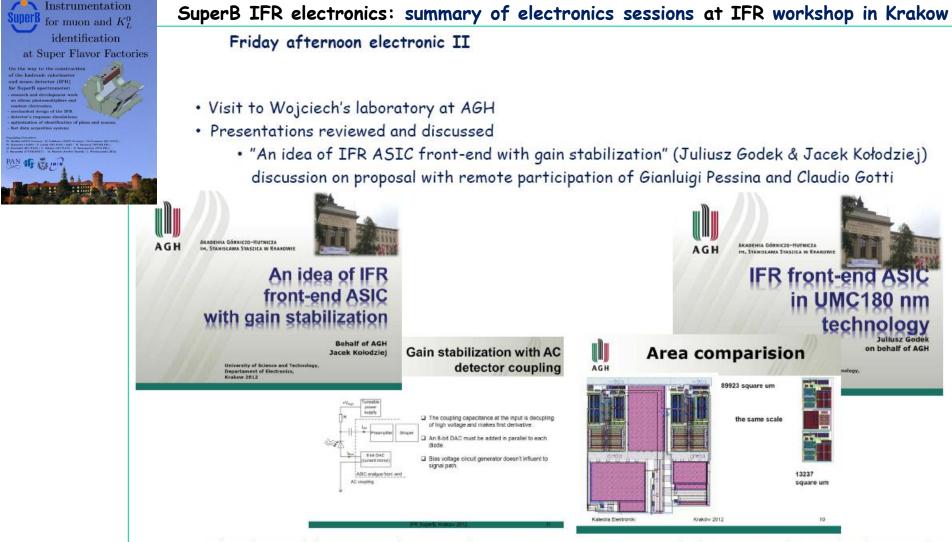
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Reasons for the test at the IRMM'S GELINA facility (proposal originated by G.



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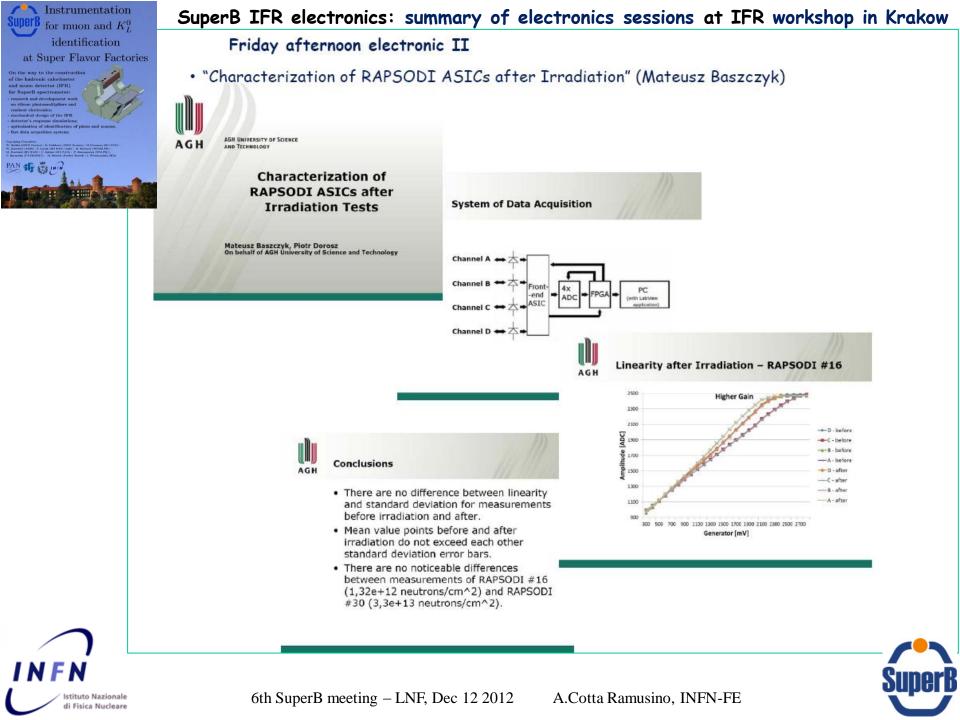
.. the thouroghly prepared proposal opens perspectives toward the usage of a technology node which lower costs provides higher density and rad tolerance but it has, like all new things some disadvantages w.r.t. to the technology considered so far for front end ASIC... to be discussed further



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SuperB IFR electronics: summary of electronics sessions at IFR workshop in Krakow

Electronics parallel sessions summary

Saturday morning joint electronics/mechanics Saturday morning joint electronics/R&D

From these joint sessions good suggestions came regarding the subjects of:

- redundancy of SiPM
- machining of scintillating bars (grooves on top and bottom)

which have impact on the design of the detector electronics but could reduce the detector manufacturing time and improve the reliability of the overall system.

The topic of Quality Control (Q.C.) was addressed at the joint electronics/R&D session: three steps were identified:

- quick verification, by means of test systems based on RAPSODI #2 chips, of SiPM gain @ nominal operating conditions
- Q.C. of assembled detector element: spectrum from <sup>90</sup>Sr sorce collected
- long term Q.C. of assembled module: cosmic ray spectrum acquired via the final readout chain while detector modules are in storage



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SuperB IFR electronics: plans for the development of an IFR frontend ASIC outlined at IFR workshop in Krakow

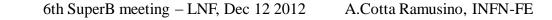
## IFR ASIC Front-End Design Team Work Proposal



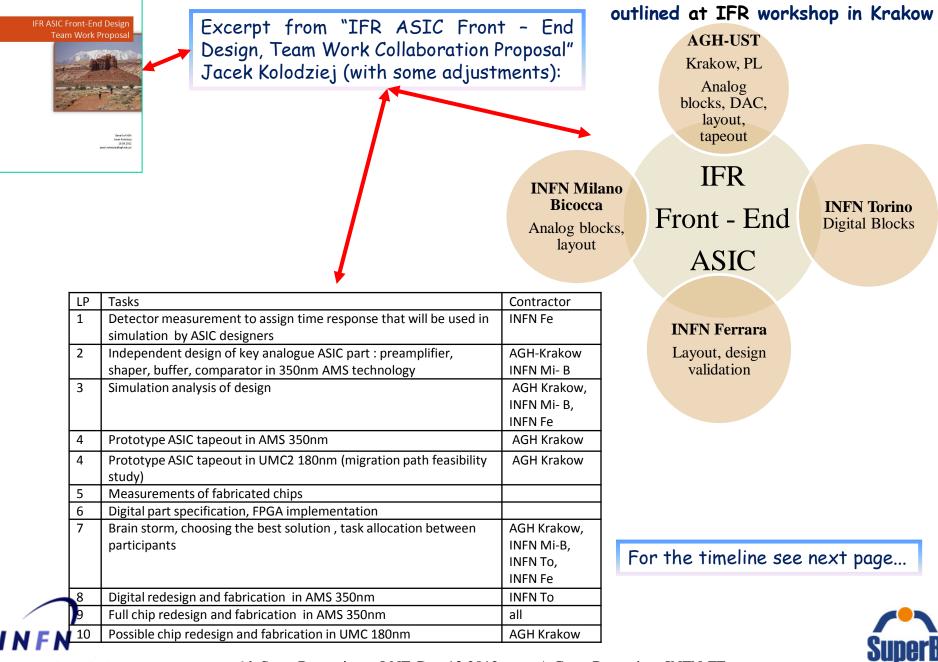
Behalf of AGH Jacek Kolodziej 16.09.2012 jacek.kolodziej@agh.edu.pl A summary of the colloquium was drafted by Jacek Kolodziej

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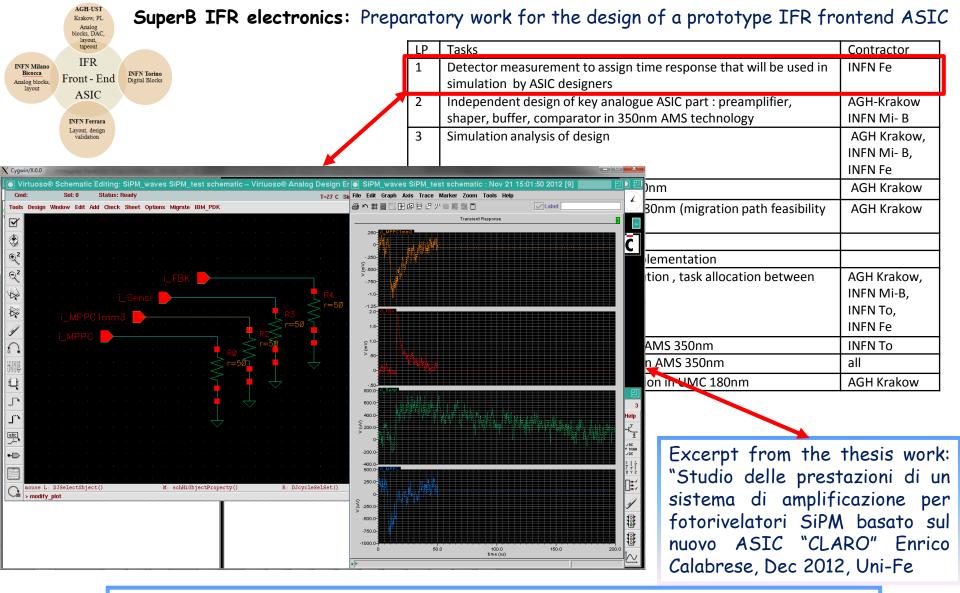
SuperB IFR electronics: plans for the development of an IFR frontend ASIC



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	19	<b>V</b>	1.7.2	DCH	55	81	3539.8	219.925	1180	04/01/13	10/06/17										
5	55	<b>V</b>	1.7.3	PID Barrel (32k channels)	138	18		510													
	75		1.7.4	EMC	110	164	2271.{	2271.5													
_	93		1.7.5		32.1	40.0			100	01/21/13	00/28/10				-						
	94	<b>V</b>	1.7.5.1	"IFR Front End" ASIC small scale prototype  "IFR Front End" ASIC full scale device (total need about 1000 pcs)	6.6		J	35		01/21/13	07/19/13										
. 10		<	1.7.5.2	"IFR Front End" ASIC full scale device (total need about 1000 pcs)     "IFR Front End" cards (total need about 400)	2.5	9.5 3	30	30		07/22/13						_					
11	-		1.7.5.4	"IFR Front End" card installation fixtures for the BARREL section	1.1	3.2		19		06/27/14						_					
11		₹	1.7.5.5	"IFR Front End" card cages (mechanics only) for the ENDCAPs	0.9	2.4		13	68		09/30/14										
12	_		1.7.5.6	"IFR data merger" cards (total need about 60)	6.5	6.5	59	59	241	06/27/14	05/29/15							1			
12	28	<b>V</b>	1.7.5.7		3	4	56	58													
• 13	34	V	1.7.5.8	$\circledast$ "detector and Front End" supply system (DEVELOPED BY THE SUPPLY G	) ł	0	110	110				<u> </u>									
13	37	V	1.7.5.9	$\circledast$ "data merger" supply system (DEVELOPED BY THE SUPPLY GROUP)	0	0	14	14													
13	-		1.7.5.10	❀ data (double shield, multi TP) cable assemblies (354 units)	1.2	4.5		44		09/30/14											
14	_		1.7.5.11	HV cables to "IFR Front End" cards, LSZH double shielded TP	1.2	4.5		21		10/17/14											
15			1.7.5.12	LV cables to the "IFR Front End" cards, LSZH, 2 cond, 2.5 sq.mm	1.2	4.5		73		10/17/14	02/20/15										
15		1.8.7	1.7.5.13	LV cables to the "Data Merger" crates, LSZH, 4 cond, 4 sq.mm  Infrastructure	0.8	2	8 262	8 262		10/31/14 05/31/15	01/30/15										
16	-		1.7.0	Systems Engineering	12	30	202	202		01/01/14											
16			1.7.8	Hardware Trigger	120	0	564	564		01/01/13											
17			1.7.9	ETD (without Trigger)	218	6	1487	1487			05/31/17										
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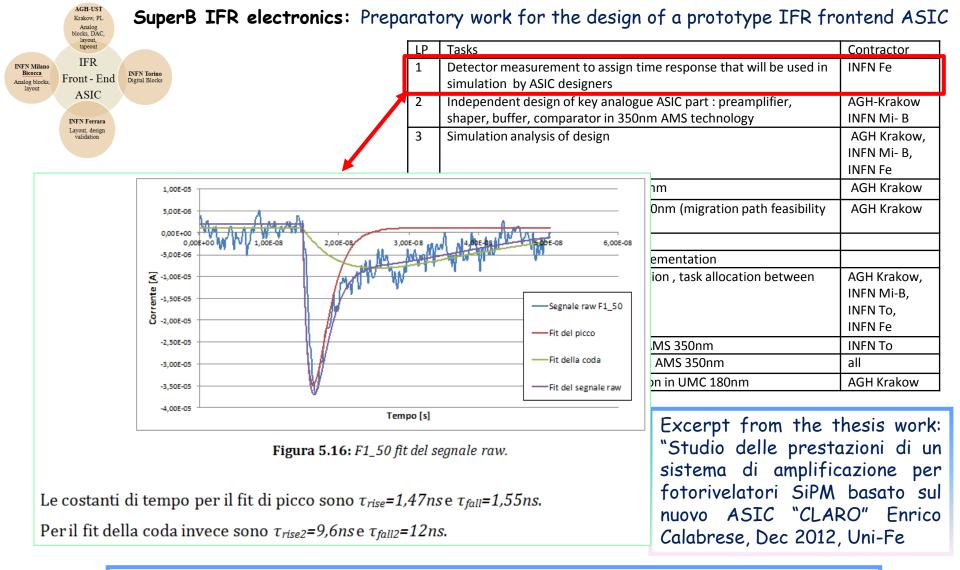


The signals from three SiPM devices were provided to the ASIC designers of INFN-Mi Bicocca and AGH Krakow in the form of stimulus files in the format comaptibile with the Cadence Spectre simulator

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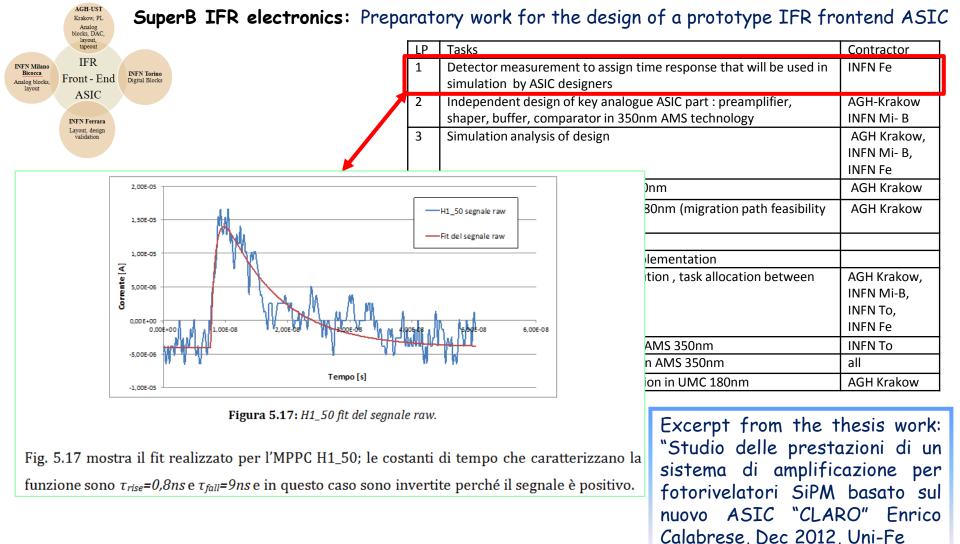
The signals from three SiPM devices were also provided to the ASIC designers of INFN-Mi Bicocca and AGH Krakow in the form of fitting functions based on linear combinations of exponential and Heaviside functions: here is shown the fitting function for an Advansid (FBK) 1mm sq, 50um pitch device



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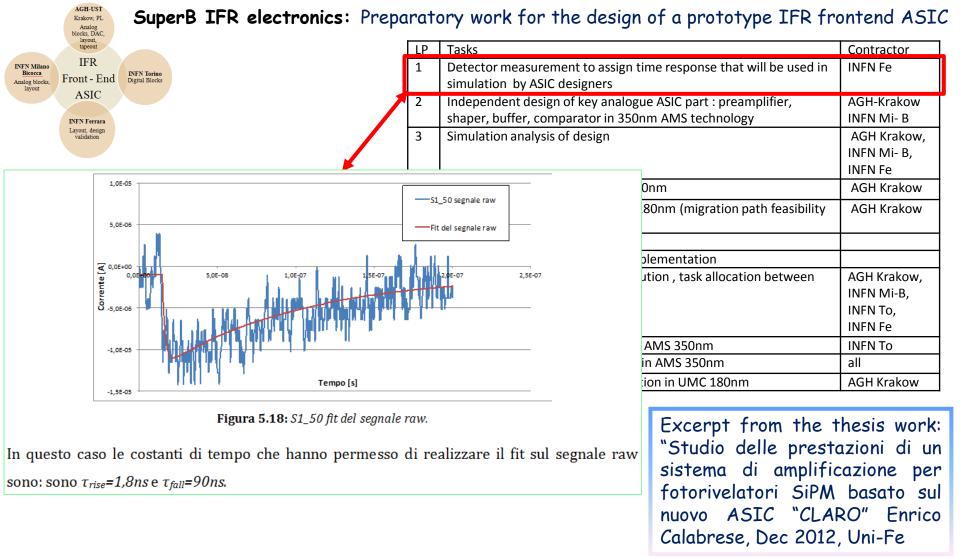
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the fitting function for an Hamamatsu MPPC 1mm sq, 50um pitch device

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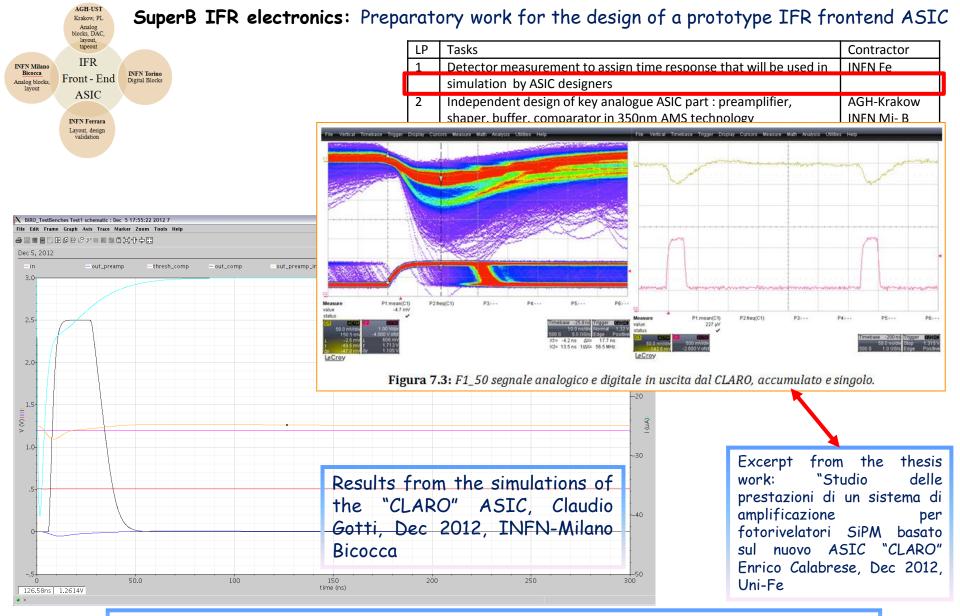




## the fitting function for a Sensl 1mm sq, 50um pitch device





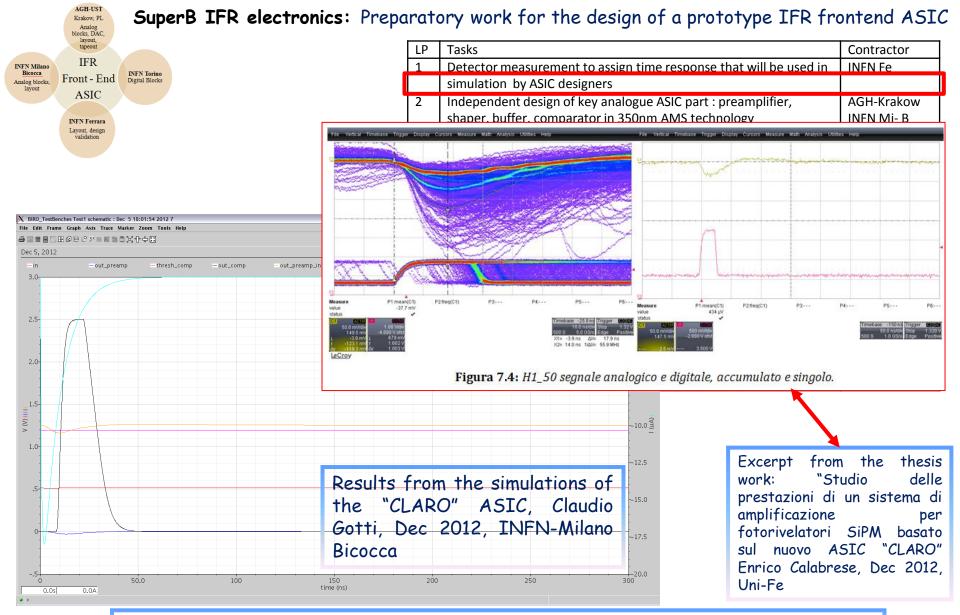


Response to the 1 photoelectron signal from an Advansid 1mm sq, 50um pitch device

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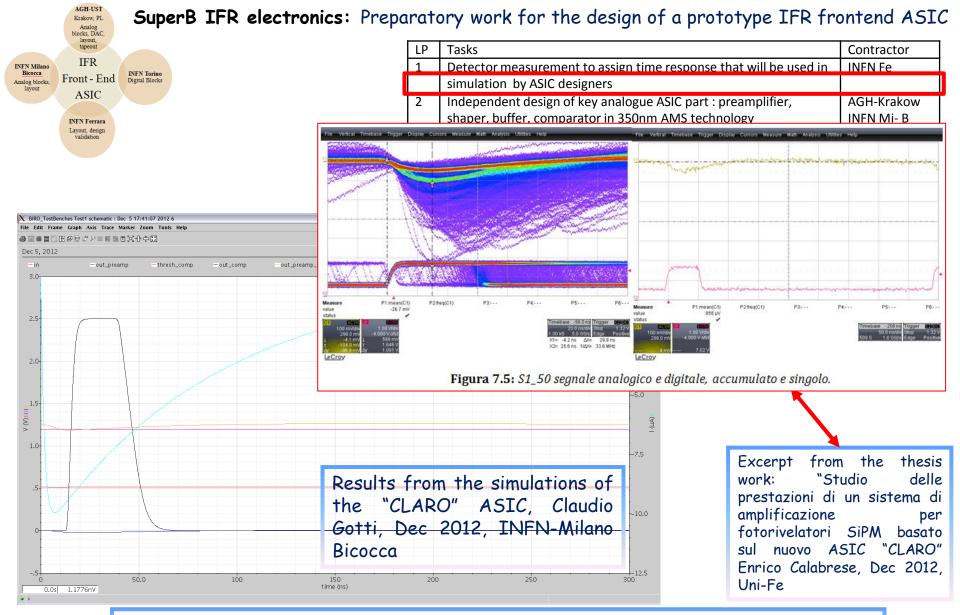


Response to the 1 photoelectron signal from an MPPC 1mm sq, 50um pitch device

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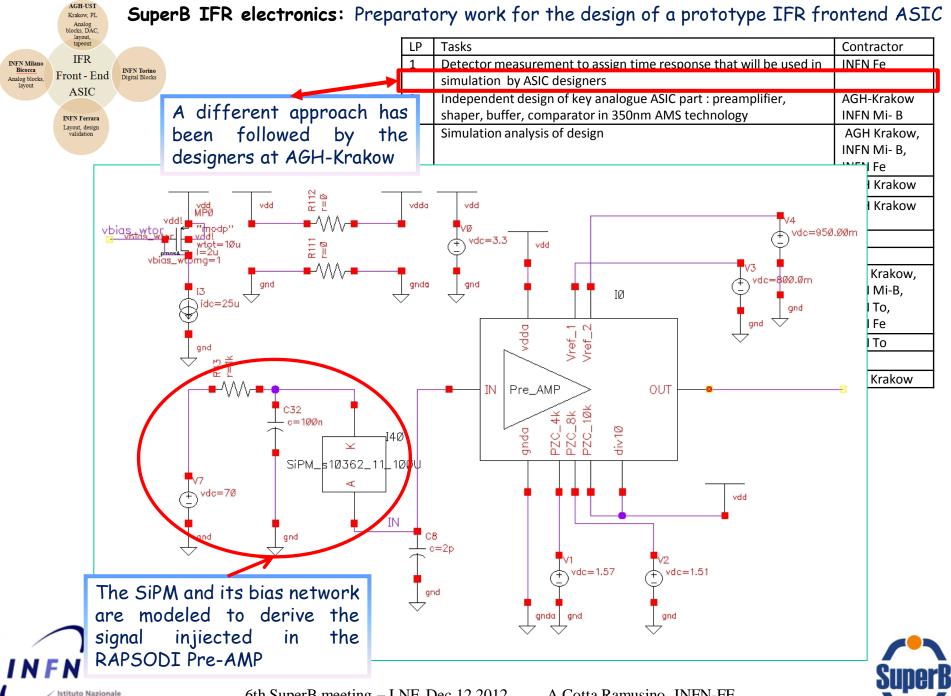


Response to the 1 photoelectron signal from a SensL 1mm sq, 50um pitch device

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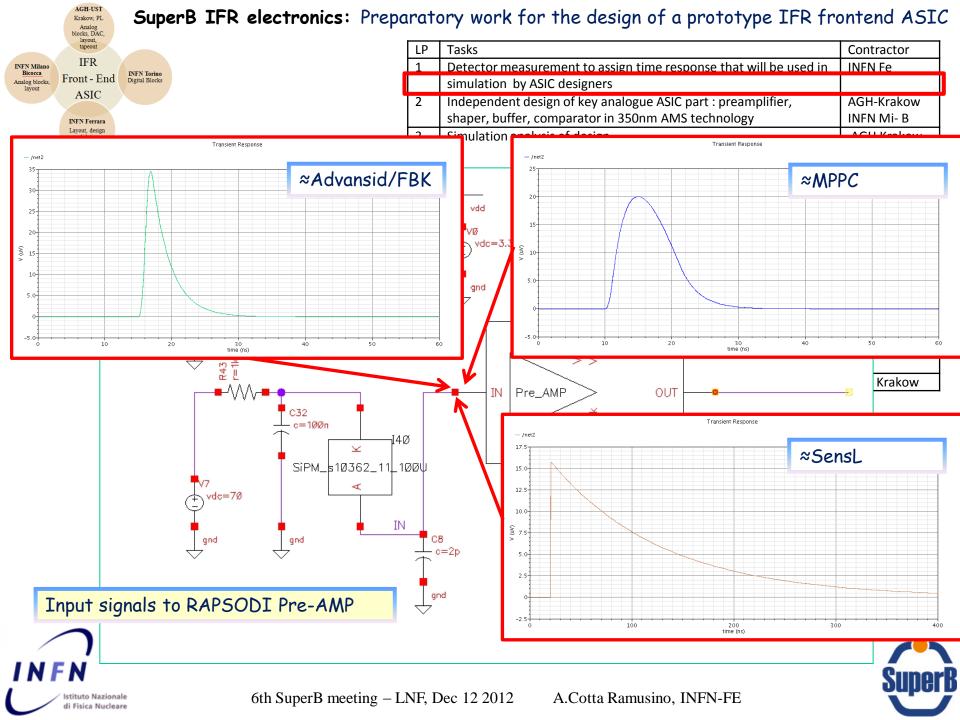
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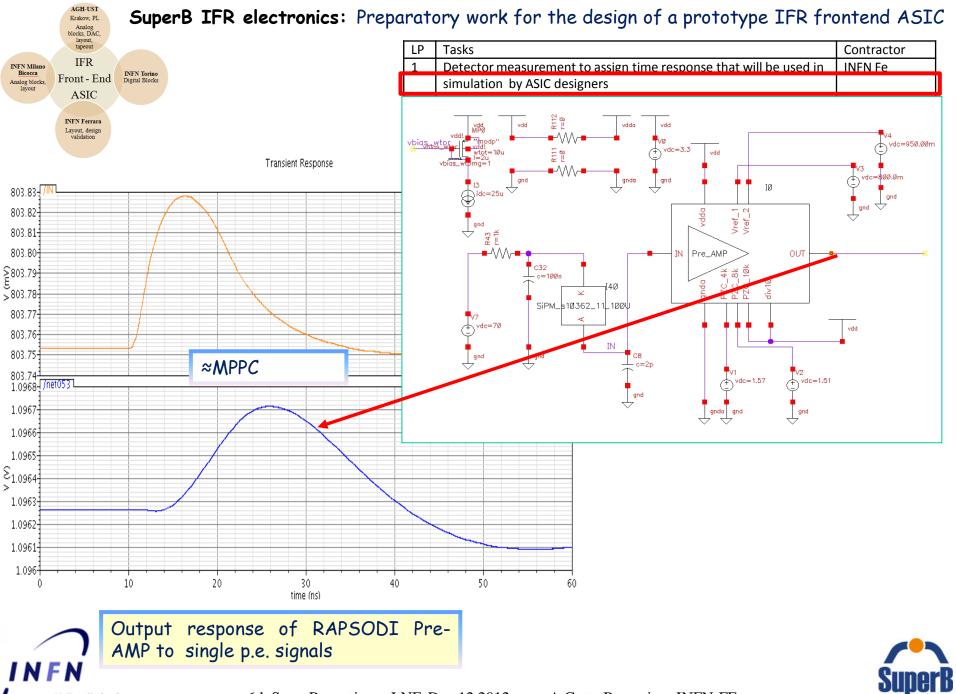




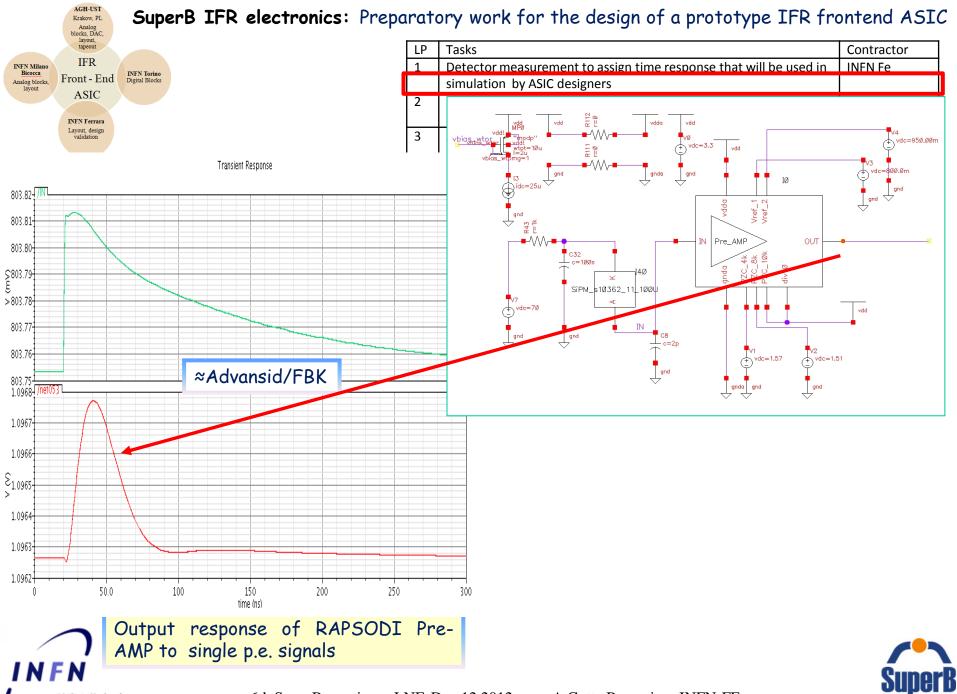
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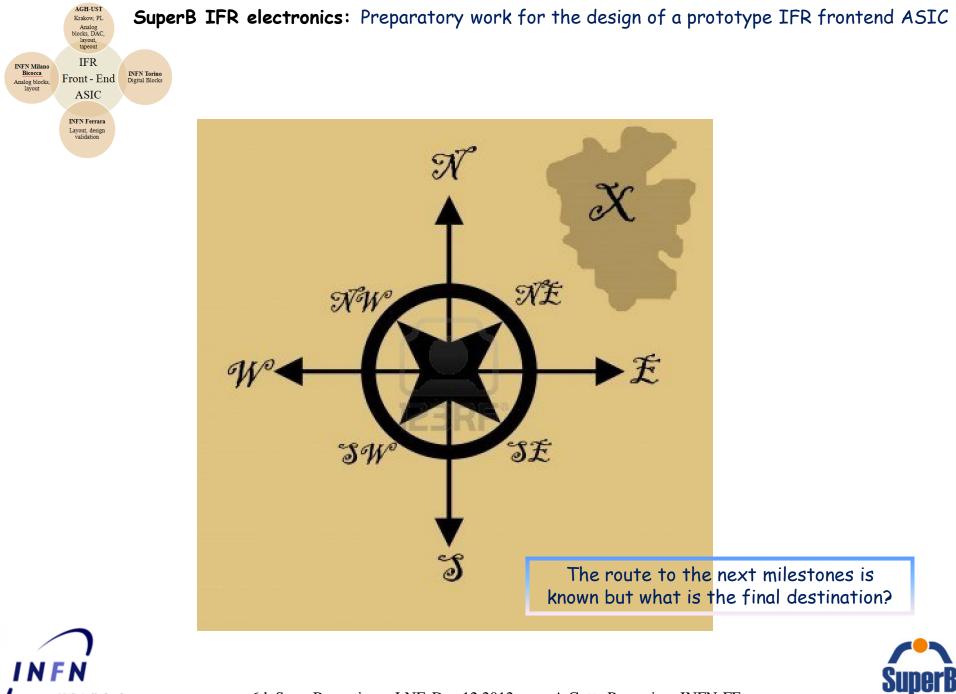




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